

Environmental Information Sheet

Product	Contactors AF116-30, AF140-30, AF146-30
ID number	1SFL42700xRxxxx, 1SFL44700xRxxxx, 1SFL46700xRxxxx
Information Provider (name and email)	Gunnar Johansson, gunnar.c.johansson@se.abb.com
Division	Low Voltage Products
Date	2012-11-02

Content of hazardous materials and recycling information.

Declare the presence (\checkmark/\times) of hazardous materials in the product (only declare materials with concentration values higher than those stated in the ROHS directive). Printed circuit boards are declared separately under and should be excluded from the declaration in the table below.

If recycling information is available for the product, refer to relevant document. If recycling information is not available, specify the component/part/physical position where the material is present.

Material	Application	√/×	Quantity	Recycling Information
Arsenic and arsenic compounds	Electronic equipment	√	0	
Asbestos	E.g. thermal insulation	✓	0	
Beryllium and beryllium compounds	Contact springs	✓	0	
Cadmium and cadmium compounds	Batteries, switches, additive in lead	√	0	
Chrome (VI+)	Surface treatment	√	0	
Decabromodiphenyl ether	Electric and electronic equipment covered by RoHS	✓	0	
Epoxy low molecular	Resin, glue, encapsulation of electrical components	√	0	
Lead and lead compounds	Batteries, cables	✓	0	
Lead chromate	Surface treatment	√	0	
Mercury and mercury compounds	Batteries, switches	✓	0	
Polybrominated diphenyl-ethers (PBDE)	Additive in plastics or rubber	√	0	
Polybrominated biphenyls (PBB)	Additive in plastics or rubber	✓	0	
Polychlorinated biphenyl (PCB)	E.g. transformers & capacitors	✓	0	
Polyvinyl chloride, PVC	Cables	√	0	
Zinc chromate	Surface treatment	√	0	

Printed circuit boards

Specify (\checkmark) the amount of printed circuit boards with lead soldering used in the product by declaring the total board surface.

Printed circuit board surface	
< 1 dm ²	
1-10 dm ²	
> 10 dm ²	
No printed circuit boards with lead soldering used in product	